

# New Software Version 5.u66

## For mModule uDOC

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### Description

- A new software version 5.u66 has been released for mModule™ uDOC. This version replaces the current software version 5.u43 in mModule uDOC configurations above 128MB. mModule uDOC 256MB that has 2 flash devices of 128MB will also stay 5.u43 based.
- The new software version offers support for the SLC NAND flash components that are manufactured using the 60 nm process, commonly available in today's market.
- No changes were made to mModule uDOC product specifications.
- A new capacity has been released – 4096MB (4GB).
- Table 1 shows the specification of the updated versions according to capacities and configurations:

*Table 1: Updated Versions according to Capacities and Configurations*

Capacity [MB]	Configuration	Horizontal	Low Profile
32 PB Free	1 flash	A 5.u43	B 5.u43
64 PB Free	1 flash	A 5.u43	A 5.u43
128 PB Free	1 flash	A 5.u43	A 5.u43
256 PB Free	2 flash	A 5.u43	A 5.u43
256 PB Free	1 flash	A 5.u66	A 5.u66
512 PB Free 1	1 & 2 flash	A 5.u66	A 5.u66
1024 PB Free	1 & 2 flash	A 5.u66	A 5.u66
2048 PB Free	1 & 2 flash	A 5.u66	A 5.u66
4096 PB Free	2 flash	A 5.u66	A 5.u66

### Reason for Change

- The new software version 5.u66 supports the new 60nm flash process, which offers better cost structure to mModule uDOC customers, as well as improved flash availability.

### Availability

November, 2006

### How to Contact Us

Please contact your M-Systems representative or visit the mModule web page on the msystems website ([www.m-systems.com](http://www.m-systems.com)) for any further information or assistance.

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